INTEGRATED CIRCUITS

DATA SHEET

74LVU04Hex inverter

Product specification Supersedes data of 2000 Dec 18 2001 Jan 11





Hex inverter 74LVU04

FEATURES

• Wide operating voltage: 1.0 to 5.5 V

Optimized for Low Voltage applications: 1.0 to 3.6 V

 Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, $T_{amb} = 25 \, ^{\circ}C.$

 Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25 \, ^{\circ}C.$

Output capability: standard

I_{CC} category: SSI

DESCRIPTION

The 74LVU04 is a low-voltage, Si-gate CMOS device and is pin compatible with the 74HCU04.

The 74LVU04 is a general purpose hex inverter. Each of the six inverters is a single stage with unbuffered outputs.

QUICK REFERENCE DATA

GND = 0 V; T_{amb} = 25 °C; t_r = $t_f \le 2.5$ ns

dillo		-		
SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay nA to nY	$C_L = 15 \text{ pF};$ $V_{CC} = 3.3 \text{ V}$	6	ns
C _I	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per gate	Notes 1, 2	18	pF

NOTES:

- 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW) $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; C_L = output load capacitance in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V; $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

 2. The condition is V_I = GND to V_{CC} .

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	−40 to +125 °C	74LVU04N	74LVU04N	SOT27-1
14-Pin Plastic SO	–40 to +125 °C	74LVU04D	74LVU04D	SOT108-1
14-Pin Plastic SSOP Type II	−40 to +125 °C	74LVU04DB	74LVU04DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40 to +125 °C	74LVU04PW	74LVU04PWDH	SOT402-1

PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION			
1, 3, 5, 9, 11, 13	1A – 6A	Data inputs			
2, 4, 6, 8, 10, 12	1Y – 6Y	Data outputs			
7	GND	Ground (0 V)			
14	V _{CC}	Positive supply voltage			

FUNCTION TABLE

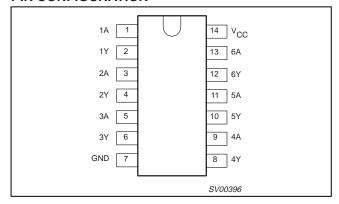
INPUTS	OUTPUTS
nA	nY
L	Н
Н	L

NOTES:

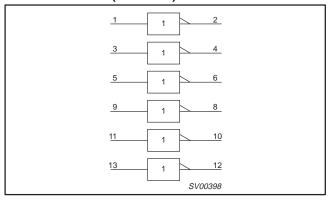
H = HIGH voltage level L = LOW voltage level

Hex inverter 74LVU04

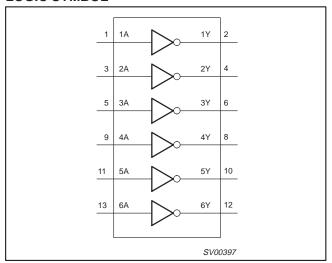
PIN CONFIGURATION



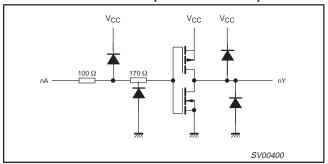
LOGIC SYMBOL (IEEE/IEC)



LOGIC SYMBOL



SCHEMATIC DIAGRAM (ONE INVERTER)



RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{CC}	DC supply voltage	See Note 1	1.0	3.3	5.5	V
V _I	Input voltage		0	_	V _{CC}	V
Vo	Output voltage		0	_	V _{CC}	V
- /	Operating ambient temperature range in free air	See DC and AC	-40		+85	°C
T _{amb}	Operating ambient temperature range in free all	characteristics	-40		+125	-0
		$V_{CC} = 1.0 \text{ to } 2.0 \text{ V}$	_	_	500	
	Input sign and fall times	$V_{CC} = 2.0 \text{ to } 2.7 \text{ V}$	_	_	200	ns/V
t _r , t _f	Input rise and fall times	V _{CC} = 2.7 to 3.6 V	_	_	100	115/V
		V _{CC} = 3.6 to 5.5 V	_	-	50	

NOTE:

2001 Jan 11

^{1.} The LV is guaranteed to function down to V_{CC} = 1.0 V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2 V to V_{CC} = 5.5 V.

Hex inverter 74LVU04

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
±I _{IK}	DC input diode current	$V_I < -0.5 \text{ or } V_I > V_{CC} + 0.5 \text{ V}$	20	mA
±I _{OK}	DC output diode current	$V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5 \text{ V}$	50	mA
±IO	DC output source or sink current – standard outputs	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	25	mA
±I _{GND} , ±I _{CC}	DC V _{CC} or GND current for types with – standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
Ртот	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125 °C above +70 °C derate linearly with 12 mW/K above +70 °C derate linearly with 8 mW/K above +60 °C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-4	0 to +85	°C	–40 to	+125 °C	UNIT
			MIN	TYP ¹	MAX	MIN	MAX	1
		V _{CC} = 1.2 V	1.0			1.0		
V _{IH}	// HIGH level Input	V _{CC} = 2.0 V	1.6			1.6		V
VIН	voltage	V _{CC} = 2.7 to 3.6 V	2.4			2.4		1 °
		V _{CC} = 4.5 to 5.5 V	0.8*V _{CC}			0.8*V _{CC}		1
		V _{CC} = 1.2 V			0.2		0.2	
VIL	LOW level Input	V _{CC} = 2.0 V			0.4		0.4] _v
۷IL	voltage	V _{CC} = 2.7 to 3.6 V			0.5		0.5	1 °
		V _{CC} = 4.5 to 5.5 V			0.2*V _{CC}		0.2*V _{CC}	1
		$V_{CC} = 1.2 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$		1.2				
		$V_{CC} = 2.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$	1.8	2.0		1.8		1
V _{OH} HIGH level output	voltage	$V_{CC} = 2.7 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$	2.5	2.7		2.5		V
	Vollage	$V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$	2.8	3.0		2.8		1
		$V_{CC} = 4.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$	4.3	4.5		4.3		1
V _{OH}	HIGH level output	$V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 6 \text{ mA}$	2.40	2.82		2.20		V
VOH	voltage	$V_{CC} = 4.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 12 \text{ mA}$	3.60	4.20		3.50		1 °
		$V_{CC} = 1.2 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0				
		$V_{CC} = 2.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	1
V_{OL}	LOW level output voltage	$V_{CC} = 2.7 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	V
	Vollago	$V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	1
		$V_{CC} = 4.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	1
V _{OL}	LOW level output	$V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 6 \text{ mA}$		0.25	0.40		0.50	V
V OL	voltage	$V_{CC} = 4.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 12 \text{ mA}$		0.35	0.55		0.65	1 °
±l _l	Input leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{CC} \text{ or GND}$			1.0		1.0	μΑ
I _{CC}	Quiescent supply current	$V_{CC} = 5.5 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0$			20.0		40.0	μА

NOTE:

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{1.} All typical values are measured at T_{amb} = 25 °C.

Hex inverter 74LVU04

AC CHARACTERISTICS

GND = 0 V; t_r = t_f = 2.5 ns; C_L = 50 pF; R_L = 500 Ω

	SYMBOL PARAMETER		WAVEFORM CONDITION -		LIMITS				
SYMBOL					40 to +85 °	С	-40 to -	-125 °C	UNIT
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX	
		1.2		35					
		Propagation delay Figure 1	2.0		12	14		17	
t _{PHL/PLH}	Propagation delay nA to nY		2.7		9	10		13	ns
		3.0 to 3.6		7 ²	8		10		
			4.5 to 5.5			7		9	

NOTES:

- 1. Unless otherwise stated, all typical values are measured at T_{amb} = 25 °C 2. Typical values are measured at V_{CC} = 3.3 V.

AC WAVEFORMS

 V_M = 1.5 V at $V_{CC} \geq 2.7$ V and ≤ 3.6 V

 V_{M}^{V} = 0.5 × V_{CC} at V_{CC} < 2.7 V and \geq 4.5 V V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

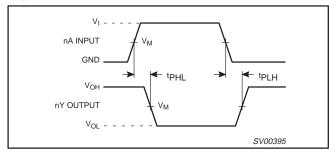


Figure 1. Input (nA) to output (nY) propagation delays and output transition times.

TYPICAL TRANSFER CHARACTERISTICS

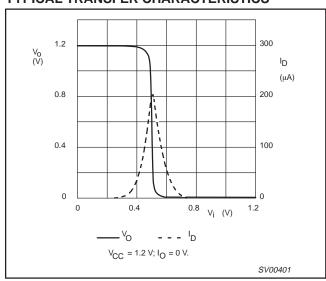


Figure 2.

2001 Jan 11 5

Hex inverter 74LVU04

TYPICAL TRANSFER CHARACTERISTICS (Continued)

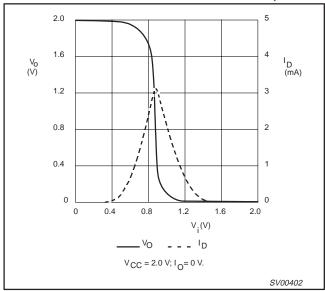


Figure 3.

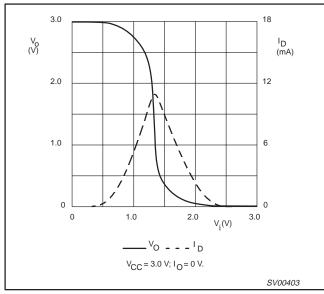


Figure 4.

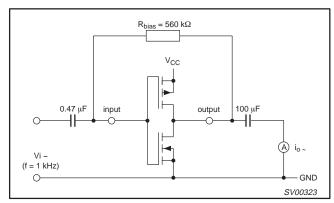


Figure 5. Test set-up for measuring forward transconductance $g_{fs} = di_O/dv_i$ at v_O is constant (see also graph Figure 6).

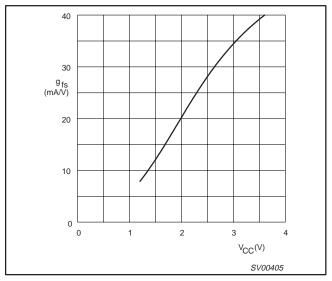


Figure 6. Typical forward transconductance g_{fs} as a function of the supply voltage V_{CC} at T_{amb} = 25 $^{\circ}C.$

Hex inverter 74LVU04

APPLICATION INFORMATION

Some applications for the 74LVU04 are:

- Linear amplifier (see Figure 7)
- In crystal oscillator designs (see Figure 8)
- Astable multivibrator (see Figure 9)

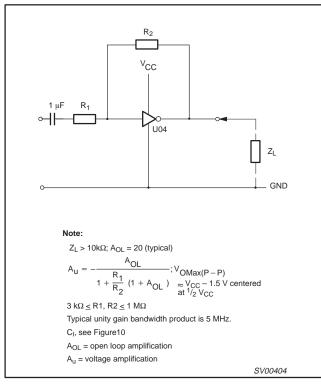


Figure 7. LVU04 used as a linear amplifier.

EXTERNAL COMPONENTS FOR RESONATOR (f < 1 MHz)

FREQUENCY (kHz)	R ₁ (MΩ)	R_2 (k Ω)	C ₁ (pF)	C ₂ (pF)
10 15.9	2.2	220	56	20
16 24.9	2.2	220	56	10
25 54.9	2.2	100	56	10
55 129.9	2.2	100	47	5
130 199.9	2.2	47	47	5
200 349.9	2.2	47	47	5
350 600	2.2	47	47	5

WHERE:

All values given are typical and must be used as an initial set-up.

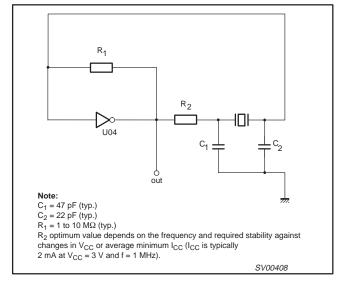


Figure 8. Crystal oscillator configuration.

OPTIMUM VALUE FOR R₂

FREQUENCY (MHz)	R_2 (k Ω)	Optimum
3	2.0 8.0	Minimum required I_{CC} Minimum influence due to change in V_{CC}
6	1.0 4.7	Minimum I _{CC} Minimum influence by V _{CC}
10	0.5 2.0	Minimum I _{CC} Minimum influence by V _{CC}
14	0.5 1.0	Minimum I _{CC} Minimum influence by V _{CC}
> 14	Repla	ace R ₂ by C ₃ with a typical value of 35 pF

Hex inverter 74LVU04

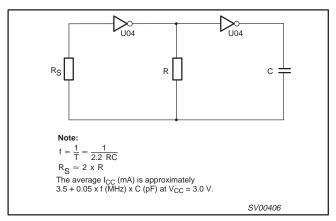


Figure 9. LVU04 used as an astable multivibrator.

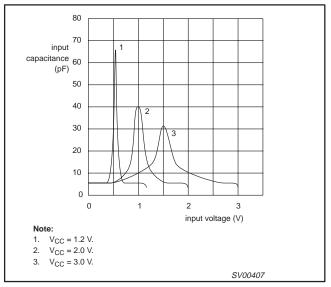


Figure 10. Typical input capacitance as function of input voltage.

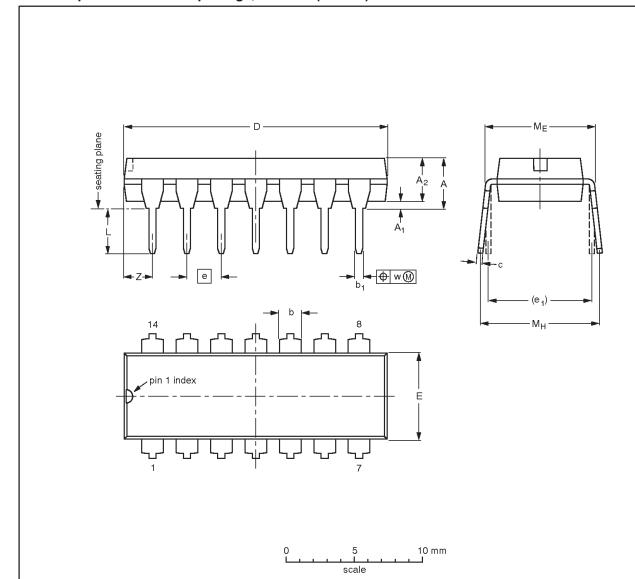
Note for Application Information

All values given are typical unless otherwise specified.

Hex inverter 74LVU04

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	Мн	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

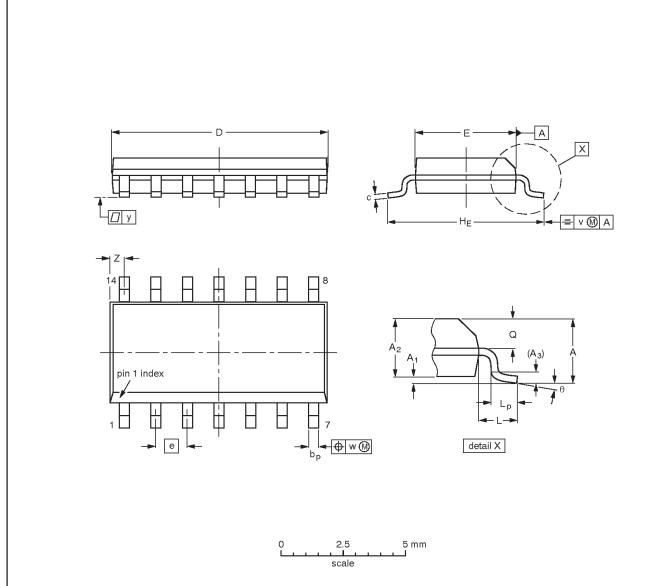
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFEF	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE
SOT27-1	050G04	MO-001	SC-501-14		95-03-11 99-12-27

Hex inverter 74LVU04

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	>	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

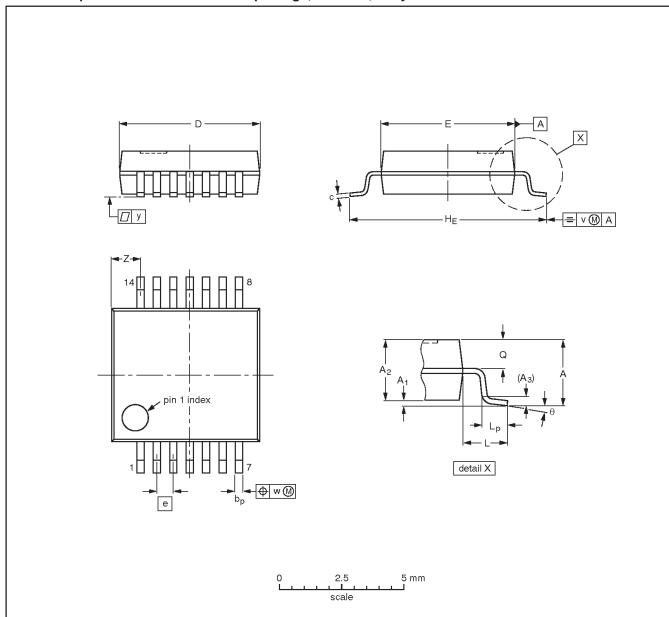
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			-97-05-22- 99-12-27

Hex inverter 74LVU04

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

						-												
UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

Note

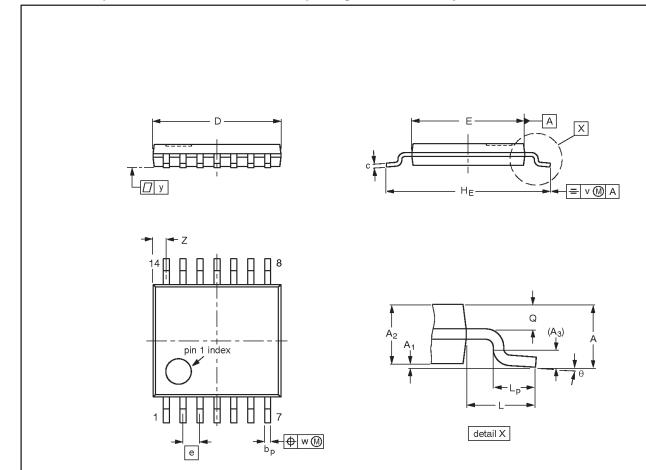
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

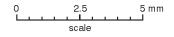
OUTLINE		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT337-1		MO-150			-96-01-18 99-12-27

Hex inverter 74LVU04

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1





DIMENSIONS (mm are the original dimensions)

UN	IT A	. A	11	A ₂	Α3	bp	c	D ⁽¹⁾	E ⁽²⁾	e	HE	L	Lp	œ	٧	w	у	Z ⁽¹⁾	θ
mr	n 1.1	1 1	15 05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT402-1		MO-153			-95-04-04 99-12-27

Hex inverter 74LVU04

NOTES

Hex inverter 74LVU04

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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